



SSF 300V Fast-Acting Series

Descriptions

SSF 300V Fast-Acting Series provide board level primary and secondary circuit protection in a wide variety of applications. With excellent inrush current withstanding capability, excellent reliability for thermal and mechanic shock, also have a high reliability and stable solder ability, end caps are available in gold/silver/nickel plated.



Features

- Fast-Acting.
- Small size (6.1mm*2.5mm).
- Wide range of current rating available.
- Wide operating temperature range.
- Low temperature de-rating.
- RoHS compliant.
- ◆ Tape and Reel for automatic placement.
- Conflict free metals.

Standards and Agency Approvals

- Standards: In accordance with UL 248-14.
- ◆ Certification: UL/CUL.

Applications

- LED lighting
- Notebook PC
- Battery devices
- ♦ LCD/PDP devices
- LCD backlight inverter
- Portable Devices
- Power supply
- Networking devices
- PC server
- Cooling fan system

- Storage system
- ♦ Telecom system
- Wireless base station
- ♦ White goods
- Game console
- ♦ Office equipment
- Digital camera
- Industrial equipment
- Medical equipment
- Automotive devices





SSF 300V Fast-Acting Series

Electrical Characteristics

Part Number	Ampere Rating (A)	Voltage Rating Vac(V)	Breaking Capacity	Nominal Cold Resistance (Ohms)	l ² TMelting Integral(A ² .S)
SSF0250	0.25	300		0.860	0.145
SSF0300	0.30	300		0.620	0.162
SSF0315	0.315	300		0.550	0.189
SSF0375	0.375	300		0.470	0.200
SSF0400	0.40	300		0.380	0.238
SSF0500	0.50	300		0.320	0.275
SSF0600	0.60	300	50A@300V _{AC}	0.285	0.470
SSF0630	0.63	300	30A@300VAC	0.256	0.566
SSF0700	0.70	300		0.208	0.805
SSF0750	0.75	300		0.175	1.240
SSF0800	0.80	300		0.155	1.880
SSF1100	1.00	300		0.148	3.500
SSF1125	1.25	300		0.102	4.760
SSF1150	1.50	300	50A@250V _{AC}	0.085	6.305
SSF1200	2.00	300		0.044	8.950
SSF1250	2.50	300		0.043	16.025
SSF1300	3.00	300		0.033	21.560
SSF1315	3.15	300		0.029	22.750
SSF1350	3.50	300		0.027	27.050
SSF1400	4.00	300	200A@125V _{AC}	0.025	31.808
SSF1500	5.00	300		0.019	40.250
SSF1600	6.00	300		0.018	67.245
SSF1630	6.30	300		0.017	73.550
SSF1700	7.00	300		0.015	76.280

- ◆ Cold resistance and I²t value are pending due to fuse elements shall be customized;
- ◆ DC Cold Resistance are measured at <10% of rated current in ambient temperature of 25°C;
- ◆ Typical Pre-arching I²t are calculated at 10*In Current or 8ms;
- Min Interrupting Rating: 1.35*In.





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Material Details

Part Name	Material Material		
End caps	Gold/Silver Plated Brass Cap		
Body	Non-Transparent Square Ceramic Tube		
Fuse element	Cu-Ag Alloy wire		

Product Characteristics

Item	Content	Reference Standards	
Product Marking	Brand, Ampere Rating	Socay marking standards	
Operating Temperature	-55°C to 125°C	IEC60068-2-1/2	
Solderability	T=240℃±5℃,t=3sec±0.5sec, Coverage≥95%	MIL-STD-202, Method 208	
Resistance to Soldering Heat	10 sec at 260℃	MIL-STD-202, Method 210, Test condition B	
Insulation Resistance (after Opening)	10,000 ohms minimum MIL-STD-202, Method 302, Test Co		
Thermal Shock	5 cycles, -65℃ / +125℃, 15 minutes at each extreme	MIL-STD-202, Method 107, Test Condition B	
Mechanical Shock	100G's peak for 6 milliseconds, 3cycles	MIL-STD-202, Method 213, Test I	
Vibration	0.03"amplitude, 10-55 Hz in 1 min. 2hrs each XYZ=6hrs	MIL-STD-202, Method 201	
Moisture Resistance	10 cycles	MIL-STD-202, Method 106	
Salt Spray	5% salt solution, 48hrs	MIL-STD-202, Method 101, Test Condition B	





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◆ Test Condition:

All electrical test is to be conducted with the ambient air at a temperature of 25±5°C.

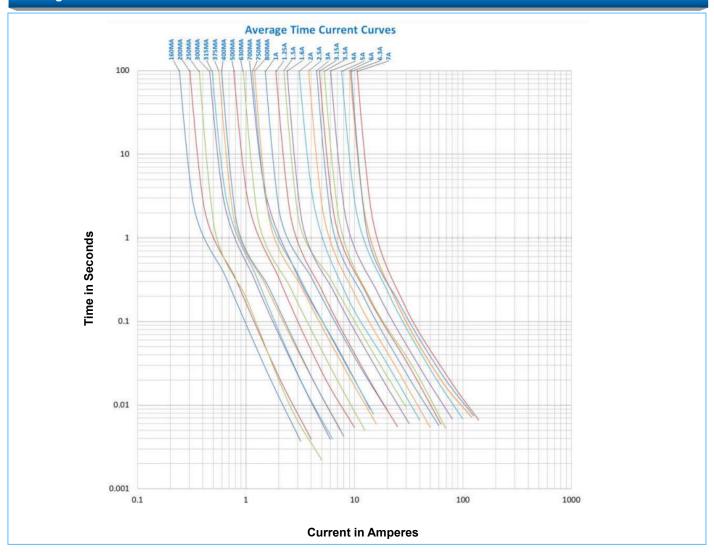
Interrupting Rating:

Breaking Capacity: 50A@300Vac,50A@250Vac,200A@125Vac.

Operating Characteristics:

% of Ampere Rating(In)	Blowing Time		
100% * In	4 hours Min		
200% * In	120 secs Max		

Average Time Current Curves



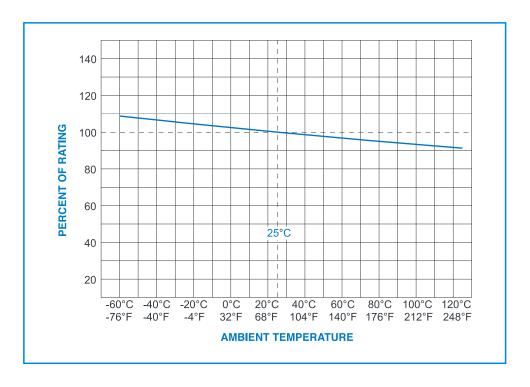




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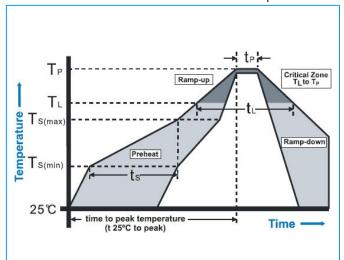
Environmental Characteristics

When choosing the fuse's specification, if the operating environmental temperature beyond the scope from $20\sim30^{\circ}$ C, engineer should consider the environmental temperature's affection to fuses. Please refer: Temperature Rerating Curve:



Recommended Soldering Parameters

- ◆ Wave / Reflow Soldering Parameters: Solder paste process; Solder Pot Temperature: 260 ℃ Max; Solder Dwell Time: 5 seconds max.
- ♦ Hand-Solder Parameters: Solder Iron Temperature: 300±5°C; Heating Time: 1~2s Max.



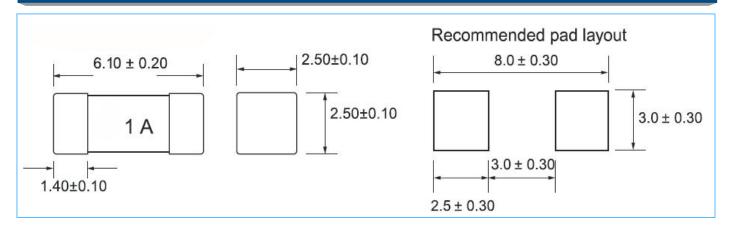
Reflow Co	ndition	Pb–free assembly	
	-Temperature Min (T _{s(min)})	150℃	
Pre Heat	-Temperature Max (T _{s(max)})	200℃	
	- Time (min to max) (ts)	60 -120 seconds	
Average ra	amp up rate (Ts(max)to Tp)	5℃ /second max.	
Reflow	- Temperature (T∟)	220℃	
Reliow	- Time Max (T _L)	60 seconds	
Peak Tem	perature (T _P)	260℃ max	
Ramp-dov	vn Rate	5℃/second max	
Time 25℃	to peak Temperature (Tp)	8 minutes max	



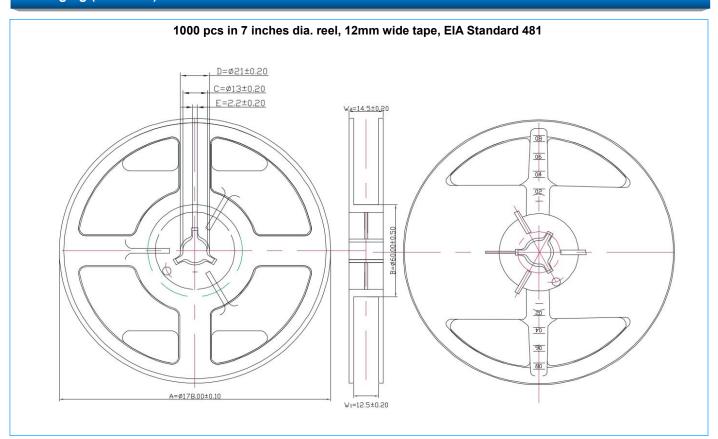


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Dimensions and Structure (Unit: mm)



Packaging (Unit: mm)



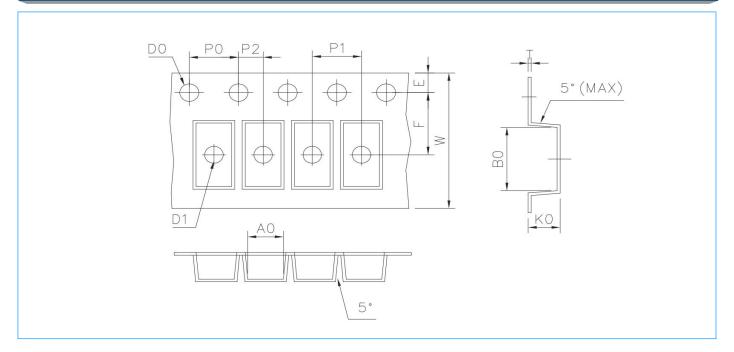
Symbol	А	В	С	D	Е	W1	W2
Spec.(mm)	178±0.10	60±0.50	13±0.20	21±0.20	2.2±0.20	12.5±0.20	14.5±0.20





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Packaging (Unit: mm) (Continue)



Symbol	A0	В0	D0	D1	E	F
Spec.(mm)	2.70±0.10	6.40±0.10	1.50+0.10	1.50+0.25	1.75±0.10	5.50±0.10
Symbol	K0	Р0	P1	P2	W	t
Spec.(mm)	2.70±0.10	4.00±0.10	4.00±0.10	2.00±0.10	12.00±0.15	0.25±0.05